



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C (Note 10)
		$12m\Omega$ @ $V_{GS} = 10V$	20A
Q1 & Q2	30V	$20m\Omega$ @ $V_{GS} = 4.5V$	17A
		$25m\Omega @ V_{GS} = 3.8V$	15A

Features and Benefits

- Low Gate Threshold Voltage
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

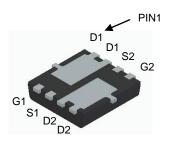
- General Purpose Interfacing Switch
- Power Management Functions

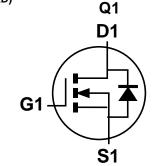
Mechanical Data

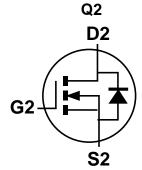
- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072 grams (Approximate)

PowerDI3333-8 (Type UXD)









Top View

Bottom View

Equivalent Circuit

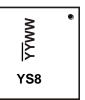
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT3009LEV-7	PowerDI3333-8 (Type UXD)	2,000/Tape & Reel
DMT3009LEV-13	PowerDI3333-8 (Type UXD)	3,000/Tape & Reel

Notes

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/. \\$

Marking Information



YS8 = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 18 for 2018)

WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Q1&Q2	Unit
Drain-Source Voltage	V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	+20, -16	V
Continuous Drain Current (Note 6) V _{GS} = 10V	I _D	20 15	Α
Maximum Body Diode Forward Current (Note 6)	I _S	2.4	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	90	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cy	I _{SM}	90	Α
Avalanche Current (Note 7) L = 0.1mH	I _{AS}	19.3	Α
Avalanche Energy (Note 7) L = 0.1mH	E _{AS}	18.6	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{θJA}	129	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	1.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	68	°C // /
Thermal Resistance, Junction to Case (Note 6)		Rejc	19	°C/W
Operating and Storage Temperature Range		$T_{J_i}T_{STG}$	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

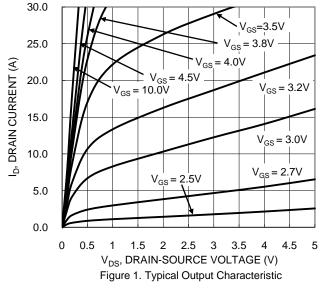
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage		30	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μA	V _{DS} = 24V, V _{GS} = 0V	
Zero Gate Voltage Drain Current T _J = +150°C (Note 9)	I _{DSS}	-	-	100	μA	$V_{DS} = 24V$, $V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = 20V, V_{DS} = 0V$ $V_{GS} = -16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)		I .				,	
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		_	9	12		$V_{GS} = 10V, I_D = 14.4A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	13	20	mΩ	V _{GS} = 4.5V, I _D = 7A	
	, ,	_	16	25		$V_{GS} = 3.8V, I_D = 5A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	V _{GS} = 0V, I _S = 10A	
DYNAMIC CHARACTERISTICS (Note 9)					•		
Input Capacitance	C _{iss}	_	823	-			
Output Capacitance	Coss	_	352	-	pF	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	C _{rss}	_	52	-			
Gate Resistance	R_g	_	1.2	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 10V)	Qg	_	12	-			
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.8	-	nC	\\\\ 45\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Gate-Source Charge	Q_{gs}	_	1.7	-	IIC	$V_{DS} = 15V, I_{D} = 14.4A$	
Gate-Drain Charge	Q_{qd}	_	2.4	-			
Turn-On Delay Time	t _{D(ON)}	_	3.2	-			
Turn-On Rise Time	t _R	_	5.2	-		$V_{GS} = 10V, V_{DD} = 15V, R_{q} = 1\Omega,$	
Turn-Off Delay Time	t _{D(OFF)}	_	8.9	-	ns	I _D = 10A	
Turn-Off Fall Time	t _F	_	1.5	_			
Body Diode Reverse Recovery Time	t _{RR}	_	16.4	-	ns	I _F = 10A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	5.9	-	nC	$I_F = 10A$, $di/dt = 100A/\mu s$	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.
- 7. UIS in production with L = 0.1mH, starting T_A = +25°C.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to product testing.

10. Package limited.





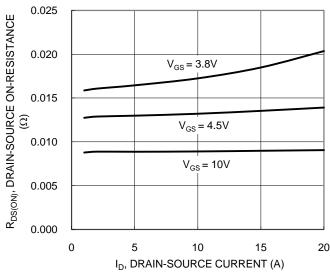


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

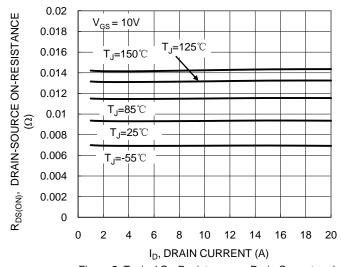


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

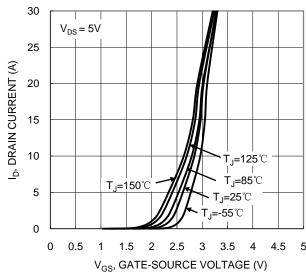


Figure 2. Typical Transfer Characteristic

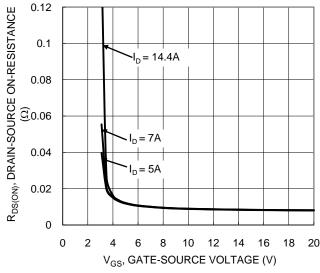


Figure 4. Typical Transfer Characteristic

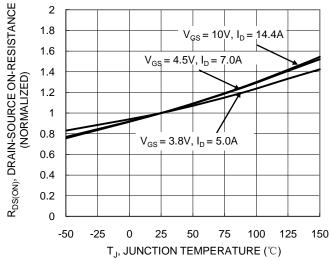


Figure 6. On-Resistance Variation with Temperature



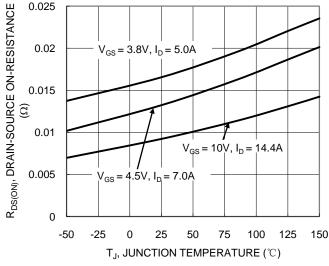
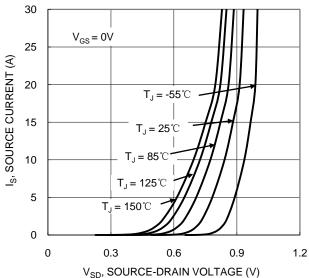


Figure 7. On-Resistance Variation with Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

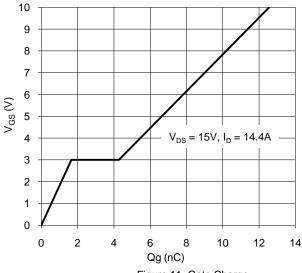


Figure 11. Gate Charge

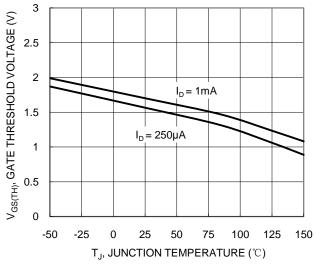
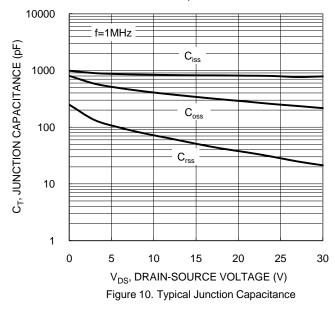
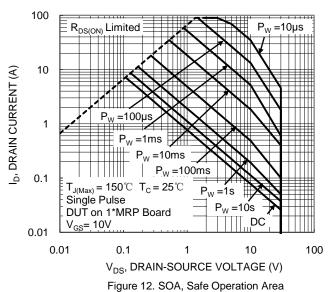
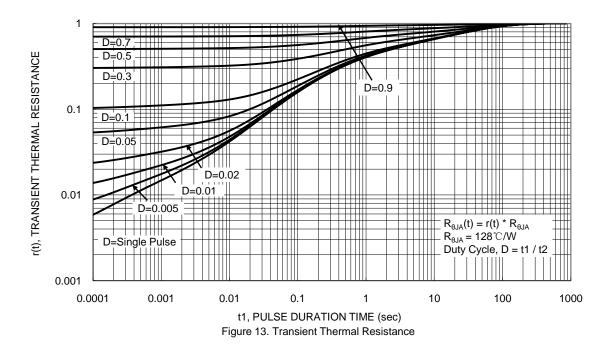


Figure 8. Gate Threshold Variation vs. Junction Temperature





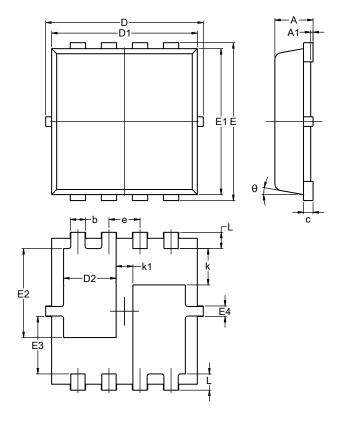




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UXD)



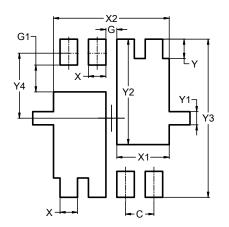
PowerDI3333-8						
(Type UXD)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05				
b	0.25	0.40	0.32			
C	0.10	0.25	0.15			
ם	3.20	3.40	3.30			
D1	2.95	3.15	3.05			
D2	0.90	1.30	1.10			
Е	3.20	3.40	3.30			
E1	2.95	3.15	3.05			
E2	1.66	2.06	1.86			
E3	1.10	1.30	1.20			
E4	0.12	0.32	0.22			
е	-	_	0.65			
L	0.24	0.44	0.34			
k	0.56	0.96	0.76			
k1	0.15	0.55	0.35			
θ	0°	12°	10°			
All Dimensions in mm						



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UXD)



1-				
Dimensions	Value (in mm			
С	0.650			
G	0.250			
G1	0.610			
Х	0.400			
X1	1.200			
X2	2.650			
Y	0.440			
Y1	0.300			
Y2	2.400			
Y3	3.600			
Y4	1.480			

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